

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3880256

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MAYAN MOUDGILL	05/12/2016
GARY NACER	04/20/2016
C. JOHN GLOSSNER	05/12/2016
A. JOSEPH HOANE	04/21/2016
MURUGAPPAN SENTHILVELAN	04/25/2016
PABLO BALZOLA	04/20/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	OPTIMUM SEMICONDUCTOR TECHNOLOGIES, INC.
<b>Street Address:</b>	120 WHITE PLAINS ROAD
<b>Internal Address:</b>	4TH FLOOR
<b>City:</b>	TARRYTOWN
<b>State/Country:</b>	NEW YORK
<b>Postal Code:</b>	10591
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15087269
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(973)422-6719
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	973-597-2500
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<b>Address Line 2:</b>	LOWENSTEIN SANDLER LLP
<b>Address Line 4:</b>	ROSELAND, NEW JERSEY 07068
<b>ATTORNEY DOCKET NUMBER:</b>	26067-32
<b>NAME OF SUBMITTER:</b>	RAYMOND G. CAPPO
<b>SIGNATURE:</b>	/Raymond G. Cappo/
<b>DATE SIGNED:</b>	05/19/2016

PATENT

**Total Attachments: 7**

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## ASSIGNMENT

WHEREAS, **WE**, **Mayan Moudgill**, a citizen of the United States residing in Chappaqua, New York, **Gary Nacer**, a citizen of the United States, residing in Morris Plains, New Jersey, **C. John Glossner**, a citizen of the United States residing in Nashua, New Hampshire, **A. Joseph Hoane**, **Paul Hurtle**, a citizen of the United States, residing in White Plains, New York, **Murugappan Senthilvelan**, a citizen of the United States, residing in Carmel, New York, and **Pablo Balzola**, a citizen of Spain residing in Madrid, Spain, ("ASSIGNOR"), have invented, developed, and/or have rights in the invention(s) ("THE INVENTION(S)") disclosed in United States Patent Application No. 15/087,269, filed March 31, 2016 (herein the "Patent");

AND WHEREAS **Optimum Semiconductor Technologies, Inc.**, a corporation having a principal place of business at 120 White Plains Road, 4<sup>th</sup> Floor, Tarrytown, NY 10591, ("ASSIGNEE") desire to acquire the entire (100%) right, title, and interest in and to THE INVENTION(S) and in and to the Patent;

NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00) in hand and/or other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to ASSIGNEE the entire right, title and interest in and to THE INVENTION(S) and the Patent and all patents and patent applications claiming priority to and/or benefit of the Patent including utilities, divisions, continuations, and continuations-in-part thereof and all reissues, reexaminations, and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all applications for patents (including related rights such as utility-model registrations, registrations, inventor's certificates, and the like) heretofore or hereafter filed for THE INVENTION(S) in any foreign country/countries, and all patents (including all extensions, renewals and reissues thereof) granted for THE INVENTION(S) and the Patent in any foreign country/countries;

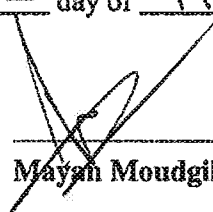
AND WE HEREBY authorize and request the United States Commissioner of Patents and Trademarks, and any officials of foreign countries whose duty is to issue patents on applications as aforesaid, to issue all patents for THE INVENTION(S) and/or the Patent in the name of ASSIGNEE in accordance with the terms of this assignment;

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith;


AND WE HEREBY further covenant and agree that we will communicate to ASSIGNEE any facts known to us respecting THE INVENTION(S) and the Patent, sign all lawful papers, execute all divisional, continuation, continuations-in-part, substitute, reexamination, and reissue applications, make all rightful oaths and generally do everything possible to aid ASSIGNEE to obtain and enforce proper patent protection for THE INVENTION(S) and the Patent.

--- SIGNATURES BEGIN ON NEXT PAGE ---

In testimony whereof, I hereunto set my hand this 12 day of MAY, 2016.

  
\_\_\_\_\_  
Maysa Moudgill

In testimony whereof, I hereunto set my hand this 20 day of APRIL, 2016.

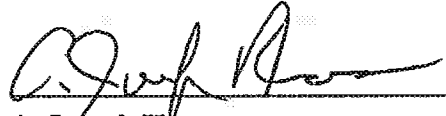
  
\_\_\_\_\_  
Gary Nacer

In testimony whereof, I hereunto set my hand this 12 day of May, 2016.



**C. John Glossner**

In testimony whereof, I hereunto set my hand this 21<sup>st</sup> day of April, 2016.

  
\_\_\_\_\_  
A. Joseph Hoane

In testimony whereof, I hereunto set my hand this 25<sup>th</sup> day of APRIL, 2016.

  
\_\_\_\_\_  
Murugappan Senthilvelan



In testimony whereof, I hereunto set my hand this 20<sup>th</sup> day of April, 2016.



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**Pablo Balzola**